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3 Additive manufacturing of Co-Ni-Ga high-temperature shape memory alloy - Processability  
4 and phase transformation behavior

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20 Co-Ni-Ga high-temperature shape memory alloy is additively processed by selective laser  
21 melting for the first time. Reversible martensitic transformation of the as-built material is proven  
22 by differential scanning calorimetry. Microstructural analysis reveals a columnar-grained  
23 microstructure due to epitaxial solidification. Columnar-grained microstructures are  
24 characterized by a very low degree of constraints being beneficial for superior functional  
25 performance in numerous shape memory alloys. However, process-induced crack formation  
26 remains a challenge towards robust realization of adequate mechanical properties.

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28 Keywords: High-temperature shape memory alloys, Co-Ni-Ga, Additive manufacturing,

29 Selective laser melting, Columnar grain

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31 Binary Ni-Ti is currently the shape memory alloy (SMA) system of choice in many niche  
32 applications due to its good biocompatibility, high transformation strains and pronounced cyclic  
33 stability. However, Ni-Ti SMAs suffer from limited transformation temperatures (TTs) and high  
34 production costs [1–3]. In order to extend the application temperature range, high-temperature  
35 (HT-) SMAs featuring increased martensite start temperatures ( $M_s$ ) have been designed. These  
36 alloys enable new applications in the fields of aerospace, automotive, oil and gas as well as  
37 other industries [4,5]. Adding a third element to Ni-Ti is a common practice to increase the TTs  
38 [4]. Ni-Ti-Hf is currently the most promising HT-SMA being in focus of many studies [6–8].  
39 However, high costs of the alloying elements as well as the highly challenging processing and  
40 machining remain major roadblocks towards the widespread use of Ni-Ti-Hf in industrial  
41 applications [9,10].

42 Over the last decades many alternative alloy systems have been introduced as HT-SMA  
43 candidates [4,5]. Among the alternative systems, the Heusler-type Co-Ni-Ga alloys have gained  
44 considerable attention [11]: Co-Ni-Ga, undergoing a martensitic transformation from cubic B2-  
45 ordered austenite to tetragonal  $L1_0$  martensite [12], consists of relatively inexpensive alloying  
46 elements and features excellent functional properties at elevated temperatures. In single  
47 crystalline state, a fully reversible pseudoelastic response up to temperatures of about 500 °C  
48 and excellent functional stability at temperatures up to 100 °C have been shown [13–15]. This  
49 qualifies Co-Ni-Ga e.g. for high-temperature damping applications. Aging of stress-induced  
50 martensite, referred to as *SIM-aging* [16], changes the chemical order and, thus, is suited to  
51 directly tailor the TTs. Hence, stable high-temperature actuation can be obtained as well [16,17].  
52 In addition, good formability can be obtained by controlled segregation of the ductile secondary  
53  $\gamma$ -phase (A1) [18–21].

54 The fundamental properties of this alloy system are well characterized. However, excellent  
55 functional properties have been reported mainly for single crystalline material so far. Owing to  
56 a pronounced anisotropic transformation behavior and a limited number of martensite variants,  
57 deformation constraints at grain boundaries (GB) cannot be sufficiently accommodated in  
58 polycrystalline material with random texture. Eventually, premature failure, i.e. intergranular  
59 fracture upon thermo-mechanical processing and/or loading is commonly observed [4,19,22].  
60 Even grain boundary engineering via segregation of the highly ductile  $\gamma$ -phase along the GBs is  
61 not capable to fully prevent cracking of unfavorable GBs in polycrystalline Co-Ni-Ga structures  
62 when martensitic phase transformation occurs [22,23]. Thus, the key towards superior shape  
63 memory performance in relatively brittle and anisotropic SMAs is the presence of  
64 microstructures, being characterized by a very low degree of grain constraints [24–26]. Triple  
65 junctions have been proven to be the most detrimental microstructural feature leading to rapid  
66 structural and functional degradation [26]. In line with those findings, a columnar-grained  
67 microstructure, featuring a strong  $\langle 001 \rangle$  texture and geometrically absolutely straight GBs of  
68 low-angle character, has been proposed to overcome these issues in case of a Cu-based SMA  
69 [27,28]. A different approach aims at realization of oligocrystals, also referred to as bamboo-  
70 like structures, in which the GBs exceed the entire cross section of the sample and are mainly  
71 oriented perpendicular to the loading axis [24,25]. Despite the obvious differences between both  
72 microstructures, i.e. columnar-grained and bamboo-like structures, the low degree of constraints  
73 is found to be vital for obtaining superior functional properties in polycrystalline SMAs, being  
74 competitive to those of their single crystalline counterparts [19,24,27,29].  
75 Recently, the group of Kainuma introduced a promising cyclic heat treatment in order to control  
76 the grain size in SMAs by abnormal grain growth (AGG) [30]. So far, AGG induced by a cyclic

77 heat treatment has been observed for Cu-Al-Mn [30,31] and Fe-Mn-Al-Ni-X [32,33] SMAs,  
78 leading to oligocrystalline grain structures or even single crystals in the range of several  
79 centimeters. In a very recent study, a novel thermo-mechanical processing route for obtaining  
80 AGG in polycrystalline Co-Ni-Ga HT-SMAs was introduced [20,21]. Hot extrusion followed  
81 by a post-processing heat treatment led to the formation of bamboo structures evoking enhanced  
82 functional performance. Nonetheless, as processing remains highly challenging, alternative  
83 procedures providing for microstructures with minimized grain constraints have to be  
84 developed.

85 In this regard, additive manufacturing (AM) technologies are highly attractive, as these  
86 techniques allow for direct microstructure design [34,35]. One of the most common AM  
87 techniques for processing of metallic materials is the powder bed based selective laser melting  
88 (SLM) method. During SLM, a laser system is used to melt a pre-alloyed powder layer by layer  
89 according to data provided by a computer-aided design file. A direct microstructural design is  
90 achieved by controlling the thermal gradient and the solidification velocity, which in turn can  
91 be adjusted by the processing parameters, such as laser power, scanning velocity, hatch distance  
92 and scanning pattern [36]. As has been shown for various materials, strongly textured columnar-  
93 grained microstructures can be obtained by SLM processing [36–39]. However, no work has  
94 been published on AM of Co-Ni-Ga in literature so far, although direct microstructure design is  
95 highly promising for obtaining excellent functional material properties. In order to close this  
96 gap, the current study focuses on the SLM processability of a Co-Ni-Ga HT-SMA.  
97 Microstructure and martensitic phase transformation behavior of SLM material have been  
98 thoroughly investigated. The general feasibility of direct microstructure design, i.e. realization

99 of a columnar-grained microstructure, is reported. Critical steps towards robust processing of  
100 the alloy are highlighted.

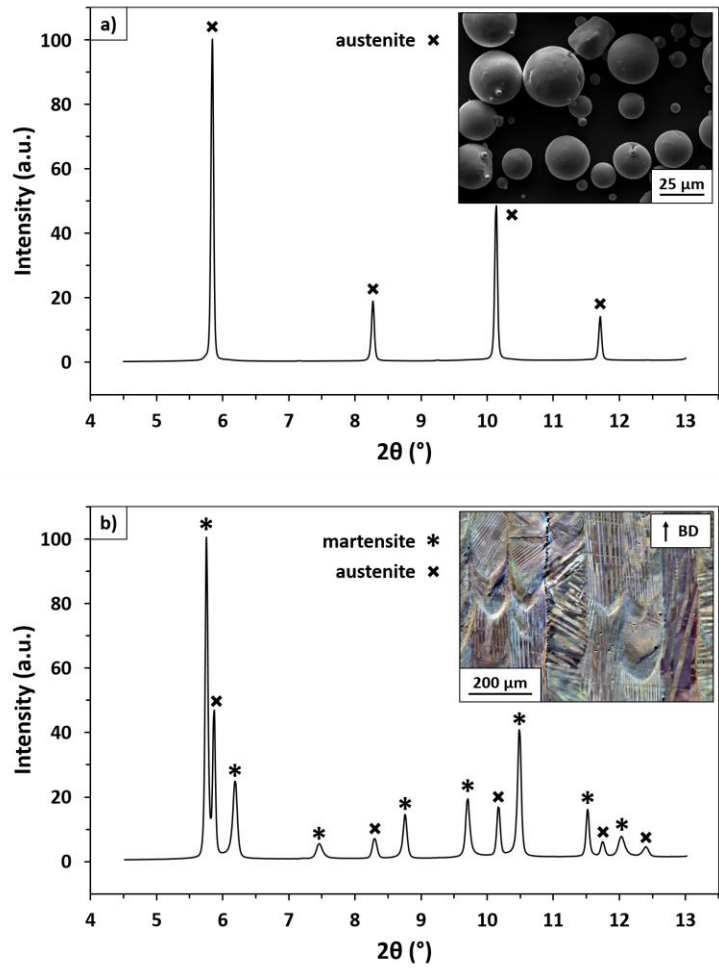
101 In the current study a SLM machine SLM280<sup>HL</sup> employing a 400 W laser was used for  
102 fabrication of specimens from a Co-Ni-Ga SMA with a nominal composition of 49Co–21Ni–  
103 30Ga (in at.%). This composition is optimized in terms of shape memory properties with a high  
104 degree of strain recoverability [15]. The chemical composition of the initial as-cast material was  
105 48.9 Co, 21.0 Ni and 30.1 Ga (in at.%) as determined by X-ray fluorescence analysis (XRF).  
106 Co-Ni-Ga SMA powder with a particle size ranging from 20 to 52  $\mu\text{m}$  was obtained by gas  
107 atomization of the as-cast material, which was carried out by TLS Technik. Chemical  
108 composition of the powder material was determined using energy-dispersive X-ray  
109 spectroscopy (EDS).  $10\times 10\times 15\text{ mm}^3$  cubes were manufactured with a layer thickness of 50  $\mu\text{m}$   
110 and a hatch distance of 0.12 mm under argon atmosphere at 110°C. The laser operated at a  
111 nominal power of 175 W and a scan velocity of 650  $\text{mm s}^{-1}$ , resulting in an energy density of  
112 45  $\text{J mm}^{-3}$ . A bidirectional scanning strategy with 90° rotation between the successive layers  
113 was employed for fabrication of all cubes. In the light of a robust processing as well as the  
114 desired microstructure characterized by a low degree of constraints the scanning strategy is  
115 suitable to reduce the process-induced residual stresses [40,41] and, concurrently, known to be  
116 beneficial for a pronounced texture evolution during processing [36].

117 The as-built cubes were cut by electrical discharge machining (EDM) along and perpendicular  
118 to the building direction (BD). Samples were ground down to 5  $\mu\text{m}$  grit size in order to remove  
119 the EDM-affected surface layer. Following grinding, samples were mechanically polished for  
120 1 h using a colloidal  $\text{SiO}_2$  suspension with 0.02  $\mu\text{m}$  particle size. For microstructure  
121 characterization, optical microscopy (OM) as well as scanning electron microscopy (SEM)

122 including energy dispersive spectroscopy (EDS) were employed. For OM, samples were etched  
123 using a solution of 33 ml ethanol, 8.5 ml H<sub>2</sub>O, 50 ml HCl and 8.5 g Cu<sub>2</sub>S. For phase analysis,  
124 synchrotron radiation and a PerkinElmer (XRD1621) area detector were employed at the P02.1  
125 high-resolution powder diffraction beamline (DESY synchrotron facility, Hamburg, Germany).  
126 Using synchrotron diffraction sample, volumes of several mm<sup>3</sup> can be probed and a detailed,  
127 high-resolution microstructure analysis is enabled. A wavelength of 0.02072926 nm was used.  
128 For further details on the synchrotron beamline P02.1 the reader is referred to [42]. Defect  
129 analysis in the sample volume was carried out using a Zeiss X-radia 520 Versa micro-computed  
130 tomography system ( $\mu$ -CT) with a sub-micron resolution. For the investigation a sample volume  
131 of 2×2×4 mm<sup>3</sup> was scanned. The  $\mu$ -CT operated at 80 kV. For analysis a sub-volume of  
132 1750×1750×3150  $\mu$ m<sup>3</sup> was extracted from the scanned sample volume in order to avoid surface  
133 effects. The voxel size was set to 3.9  $\mu$ m. Differential scanning calorimetry (DSC) was used to  
134 investigate the martensitic phase transformation behavior. DSC was conducted using a Mettler-  
135 Toledo DSC 1 calorimeter at heating and cooling rates of 10 K min<sup>-1</sup>.

136 Figure 1 shows synchrotron diffraction patterns obtained at room temperature from the initial  
137 Co-Ni-Ga powder and the SLM as-built condition. The powder particles are fully austenitic  
138 with a B2 type ordered bcc lattice, as determined from the peaks at diffraction angles between  
139 4.5° and 13° (Fig.1a). The lattice parameter of the B2 austenite is  $a = 2.865 \text{ \AA}$ . The powder  
140 particles following gas atomization feature high sphericity and only a small fraction of adhering  
141 satellites (inset in Fig.1a). Following AM, the material features a dual-phase microstructure, as  
142 can be deduced from the additional peaks in the diffraction pattern (Fig.1b). In addition to the  
143 austenitic phase with  $a = 2.858 \text{ \AA}$ , tetragonal martensite is present. The crystal structure of the  
144 martensitic phase is  $L1_0$  with lattice parameters of  $a = 2.711 \text{ \AA}$  and  $c = 3.170 \text{ \AA}$ . All lattice

145 parameters are in accordance to literature [12,43]. The slight deviation between the austenitic  
 146 lattice parameters can be attributed to process-induced residual stresses and minor changes in  
 147 chemical composition, as will be detailed hereafter. The dual-phase microstructure appears as a  
 148 lath like austenite-martensite relief in the individual grains similar to that of as-cast Co-Ni-Ga  
 149 alloys in [44,45] (s. inset in Fig. 1b).



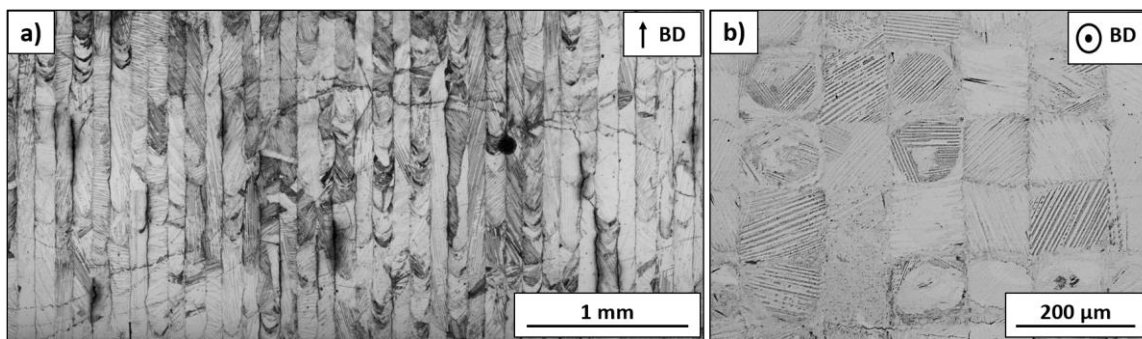
150 *Figure 1: Synchrotron diffraction patterns of (a) Co-Ni-Ga powder and (b) the SLM processed*  
 151 *material in the as-built condition. The SEM and Argus image in the insets show the powder*  
 152 *particles (a) and the as-built microstructure (b), respectively.*

153



154 The optical micrographs in Figure 2a and b depict the microstructure of the as-built material  
155 parallel and perpendicular to BD, respectively. Columnar grains with long axes in the millimeter  
156 range grow parallel to BD (Fig.2a). Owing to the partial re-melting of the underlying solid  
157 material, epitaxial solidification occurs during the SLM process [36,38] so that the resulting  
158 grain long axes are clearly larger than the initial layer thickness. Although epitaxial grain growth  
159 across individual layers was reported for various SLM fabricated materials [36–39,46,47], the  
160 strong columnarity of the as-built Co-Ni-Ga is remarkable. This is further highlighted by the  
161 grain structure resolved perpendicular to BD (Fig.2b). Due to the bidirectional scanning strategy  
162 in combination with the 90° rotation applied, a clear checkerboard like grain arrangement is  
163 formed, as also observed in e.g. [38,47] for Ta and Ni-Ti, respectively. Liu et al. [27,28] found  
164 an almost perfect pseudoelastic behavior in columnar-grained microstructures with strong  
165 crystallographic texture and absolutely straight low-energy GBs in Cu-based SMAs. In addition,  
166 even if no strong texture is present, enhanced functional properties and excellent resistance  
167 against GB cracking were shown by the current authors in a very recent study for both bamboo-  
168 like and columnar-grained Co-Ni-Ga bi-crystals [22]. Consequently, additive manufacturing via  
169 SLM is thought to be highly promising to obtain Co-Ni-Ga HT-SMAs with appropriate  
170 microstructures featuring excellent resistivity to functional and structural degradation.

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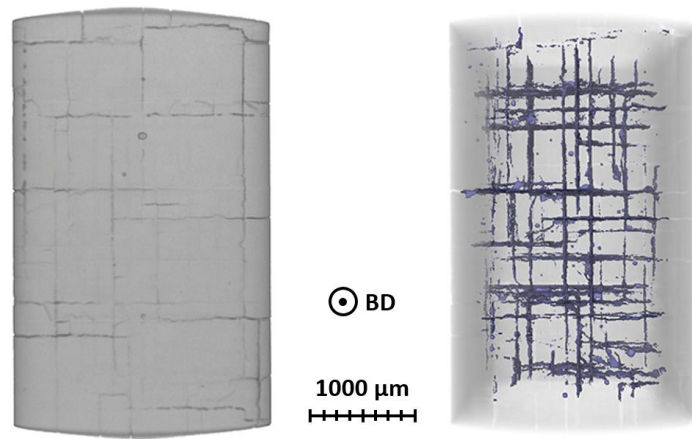
173 *Figure 2: Optical micrographs revealing the microstructure of Co-Ni-Ga processed by SLM in*  
174 *the as-built condition. The images represent the side view (a) and the top view (b) of the*  
175 *manufactured cubes, as indicated by the arrows labelled BD.*

176

177 Results from  $\mu$ -CT shown in Figure 3 reveal substantial crack formation in the columnar-  
178 grained SLM Co-Ni-Ga. A relative density of 85.6% has been determined from these results. It  
179 has to be noted that in a preceding laser parameter study material of significantly higher density,  
180 i.e. free of cracks, was obtained. However, those conditions were characterized by an  
181 unfavorable globular and fine-grained microstructure (not shown). For the sake of brevity, only  
182 the set of processing parameters leading to favorable microstructural features is presented in  
183 this paper. The cracks depicted in Figure 3 are mainly oriented parallel to the laser scanning  
184 vectors during processing. The reason for this phenomenon is seen to be rooted in residual  
185 stresses, which typically are formed due to repeated heating, solidification and cooling during  
186 layer-wise processing [48], leading to phenomena such as hot and cold cracking. In addition,  
187 owing to the high cooling rates within the process, precipitation of the ductile secondary  $\gamma$ -phase  
188 along the GBs is not observed, as can be deduced from the synchrotron analysis (Fig.1b) and  
189 the optical micrographs (Fig.2). This phase has been proven to be of highest importance to  
190 hinder intergranular crack nucleation and propagation [22,23]. The unfavorable combination of  
191 the thermally induced stresses and the high brittleness of the as-built material probably leads to  
192 cracking alongside the GBs during the SLM process. A parameter optimization including base  
193 plate heating up to 600°C is currently considered in order to obtain crack free material which  
194 simultaneously shows the desired microstructural features. Increasing the base plate  
195 temperature is seen to be very promising to reduce the process induced residual stresses in hard

196 to process alloys, e.g. tool steels [50]. Furthermore and in light of the cost efficiency of the AM  
197 process, the adjustment of the process related parameters in order to avoid process induced  
198 defects should be in focus of future work instead of using well-established post process  
199 treatment procedures, such as hot isostatic pressing (HIP). However, further process parameter  
200 optimization is clearly beyond the scope of present work.

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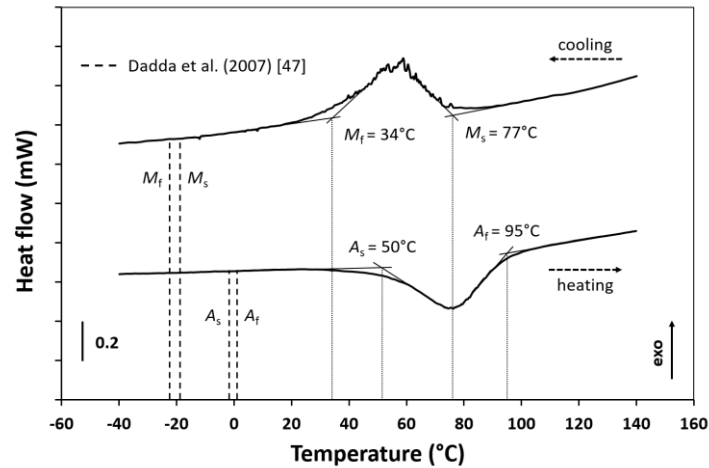
203 *Figure 3: Computed tomography analysis of as-built Co-Ni-Ga showing substantial crack*  
204 *formation after SLM fabrication: 2D image of a single plane (left), 3D visualization (right).*

205

206 The thermal phase transformation characteristics of as processed Co-Ni-Ga, revealed by DSC  
207 analysis, are shown in Figure 4. The endothermic and exothermic reactions associated with the  
208 forward and reverse martensitic transformation can be clearly identified in the DSC curve upon  
209 heating and cooling, respectively. The TTs of the as-built condition, determined using the  
210 tangent method, were found to be  $M_s=77^\circ\text{C}$ ,  $M_f=34^\circ\text{C}$ ,  $A_s=50^\circ\text{C}$  and  $A_f=95^\circ\text{C}$ . It is important to  
211 note that the synchrotron phase analysis (Fig.1b) and the optical micrographs (Fig.2) of the as-  
212 built material revealed an austenitic-martensitic dual-phase microstructure at room temperature,  
213 i.e.  $M_f$  below RT. The slight difference in TTs to the DSC results ( $M_f=34^\circ\text{C}$ ) could be due to

214 minor inhomogeneity in the microstructure, slight differences in local chemical composition  
215 and/or internal stress state [49]. At this point it has to be emphasized that the material utilized  
216 in this study was not homogenized after SLM processing. In addition, specimens for DSC had  
217 to be cut and polished, at least leading to change of residual stress state. Quantitative evaluation  
218 of the impact of each single parameter, however, is clearly beyond the scope of the present study  
219 and, thus, has to be subject of future work.

220 Still, the DSC results indicate that the absolute TTs as well as the temperature ranges for forward  
221 and reverse transformation, i.e.  $\Delta_1=A_f - A_s$  and  $\Delta_2=M_s - M_f$ , are increased compared to single  
222 crystalline  $\text{Co}_{49}\text{Ni}_{21}\text{Ga}_{30}$  [49]. The increase of  $\Delta_1$  and  $\Delta_2$  is mainly attributed to the  
223 polycrystalline state and grain constraints, respectively. The increase in TTs is thought to be  
224 rooted in a general change in chemical composition. Increased Ni and decreased Ga contents  
225 have been reported to lead to higher  $M_s$  in the Co-Ni-Ga system [44,51]. In the present study the  
226 Ga content in the as-built material was found to be about 1.0 at. % below that of both the initial  
227 as-cast as well as the powder material (as determined by EDS). Thus, the increase in TTs is  
228 mostly attributed to the evaporation of the volatile element Ga during SLM processing. As  
229 shown by Elahinia et al. [8] for a Ni-Ti-Hf HT-SMA, evaporation of nickel and oxygen pick are  
230 very influential to the transformation behavior. Further factors contributing the shift of TTs and  
231 the increase of the transformation temperature ranges  $\Delta_1$  and  $\Delta_2$  (as compared to the single  
232 crystalline material) might be process-induced defects, such as inclusions and cracks shown for  
233 Ni-Ti [52], the latter ones being very prominent in the microstructure under investigation. In  
234 contrast to the Ni-Ti-based alloys being very sensitive to the alloy composition in terms of the  
235 TTs, however, adequate post heat treatments seem to offer more efficient pathways for property  
236 optimization in Co-Ni-Ga [16,17,44].



238 *Figure 4: DSC curve for SLM Co-Ni-Ga in the as-built condition. The characteristic*  
 239 *transformation temperatures upon heating ( $A_s$  and  $A_f$ ) and cooling ( $M_s$  and  $M_f$ ) are marked. In*  
 240 *addition, transformation temperatures of single crystalline  $Co_{49}Ni_{21}Ga_{30}$  recompiled from Ref.*  
 241 *[49] are highlighted by dashed lines.*

242

243 In conclusion, the current study demonstrates for the first the time the processability of Co-Ni-  
 244 Ga HT-SMAs via SLM. Reversibility of the martensitic transformation and characteristic TTs  
 245 have been shown by DSC. By choosing a suitable set of processing parameters a favorable  
 246 microstructure is obtained directly after processing. Epitaxial growth leads to an anisotropic,  
 247 columnar microstructure being very attractive for enhanced functional properties in  
 248 polycrystalline SMA systems. Thus, it is expected that additive manufacturing of hard to form  
 249 Co-Ni-Ga will open up new possibilities to overcome major roadblocks toward application.  
 250 Avoidance of severe processing induced defects needs to be addressed in future studies in order  
 251 to evaluate the thermo-mechanical functional properties in more detail.

252

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